



## Description

### JMP N-channel Enhancement Mode Power MOSFET

#### Features

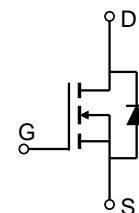
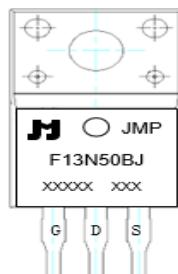
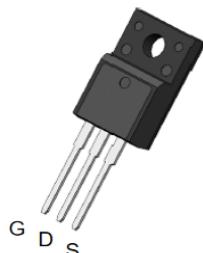
- 500V, 13A
- $R_{DS(ON)} < 0.62\Omega$  @  $V_{GS} = 10V$
- Fast Switching
- Improved dv/dt Capability

#### Applications

- Load Switch
- PWM Application
- Power Management



100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



TO-220FP-3L Top View

Marking and Pin Assignment

Schematic Diagram

#### Package Marking and Ordering Information

Device Marking	Device	Outline	Package	TUBE (pcs)	Inner Box (pcs)	Per Carton (pcs)
JMPF13N50BJ	JMPF13N50BJ	TUBE	TO-220FP-3L	50	1000	5000

#### Absolute Maximum Ratings (@ $T_C = 25^\circ C$ unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		500	V
$V_{GS}$	Gate-to-Source Voltage		$\pm 30$	V
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	13	A
		$T_C = 100^\circ C$	8	
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>		52	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>		414	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ C$	30	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(3)</sup>		50	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance, Junction to Case		4.2	
$T_J, T_{STG}$	Junction & Storage Temperature Range		-55 to 150	$^\circ C$

Electrical Characteristics ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	500	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = 500\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 30\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2	3	4	V
$R_{\text{DS(ON)}}$	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = 10\text{V}, I_D = 6.5\text{A}$	-	0.48	0.62	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	-	1645	-	pF
$C_{\text{oss}}$	Output Capacitance		-	157	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	18	-	pF
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 250\text{V}, I_D = 13\text{A}$	-	33	-	nC
$Q_{gs}$	Gate Source Charge		-	9.7	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge		-	11	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DD} = 253.5\text{V}$ $I_D = 13\text{A}, R_{\text{GEN}} = 24\Omega$	-	26	-	ns
$t_r$	Turn-On Rise Time		-	40	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	92	-	ns
$t_f$	Turn-Off Fall Time		-	42	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	13	-	A
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	52	-	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = 13\text{A}$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	$I_F = 13\text{A}, dI/dt = 100\text{A}/\mu\text{s}$	-	386	-	ns
Qrr	Body Diode Reverse Recovery Charge		-	4.2	-	$\mu\text{C}$

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2.  $E_{AS}$  condition: Starting  $T_J=25^\circ\text{C}$ ,  $V_{DD}=50\text{V}$ ,  $V_G=10\text{V}$ ,  $R_G=25\text{ohm}$ ,  $L=10\text{mH}$ ,  $I_{AS}=9\text{A}$ 3.  $R_{\theta JA}$  is measured with the device mounted on a minimum recommended pad of 2oz copper FR4 PCB4. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

## Typical Performance Characteristics

Figure 1: Output Characteristics

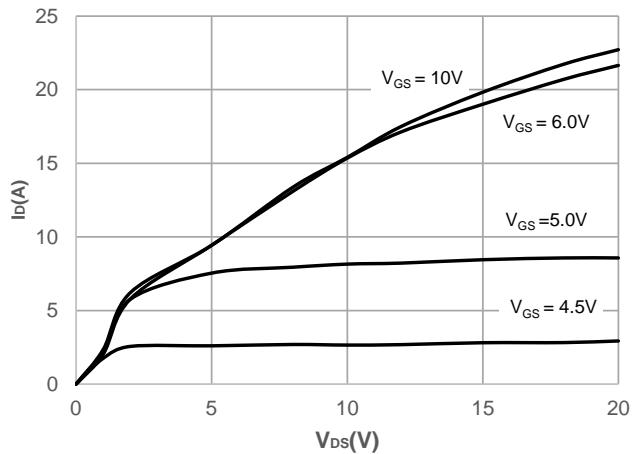


Figure 2: Typical Transfer Characteristics

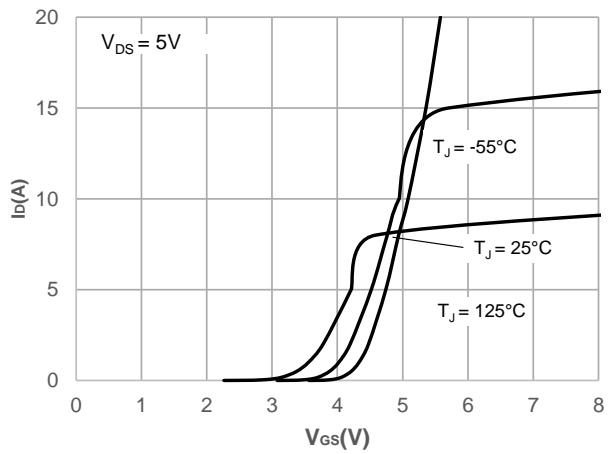


Figure 3: On-resistance vs. Drain Current

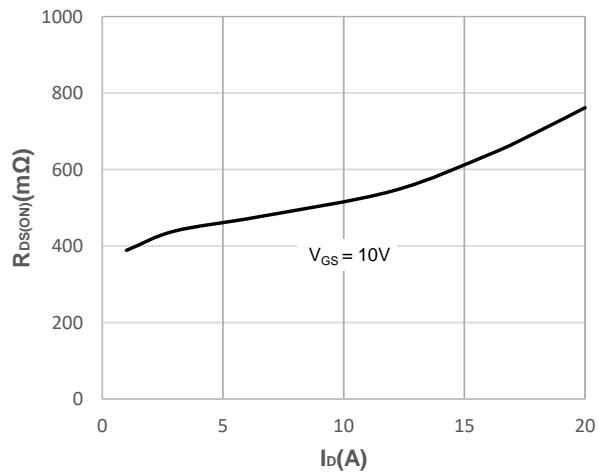


Figure 4: Body Diode Characteristics

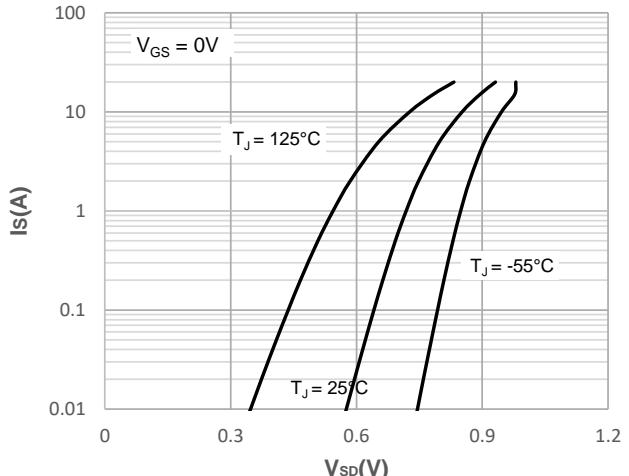


Figure 5: Gate Charge Characteristics

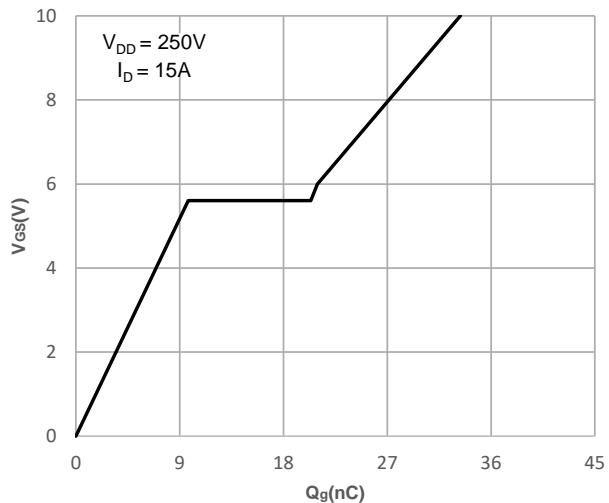
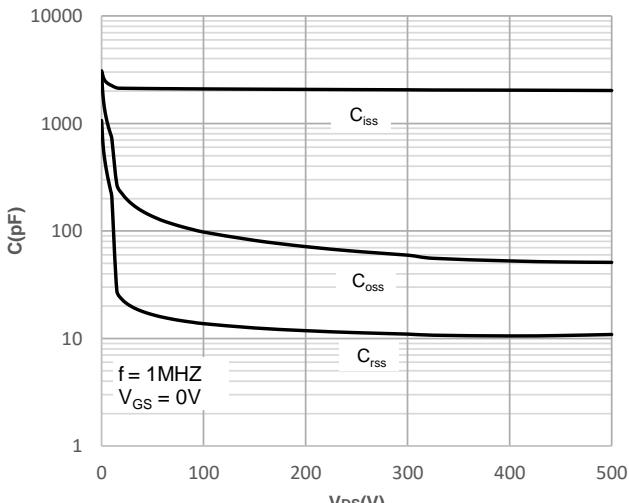
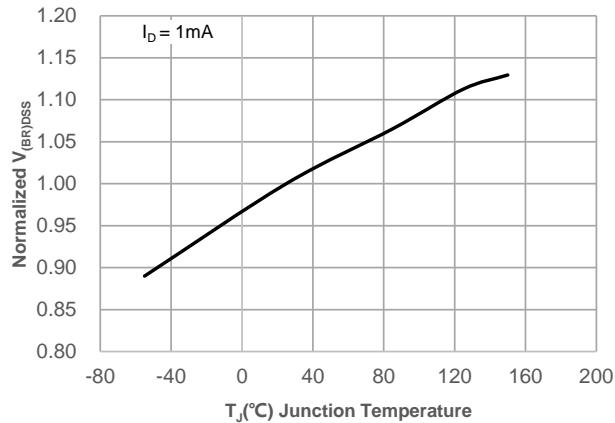


Figure 6: Capacitance Characteristics

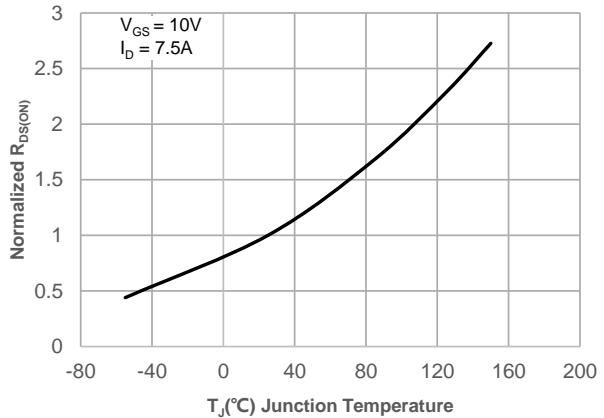


## Typical Performance Characteristics

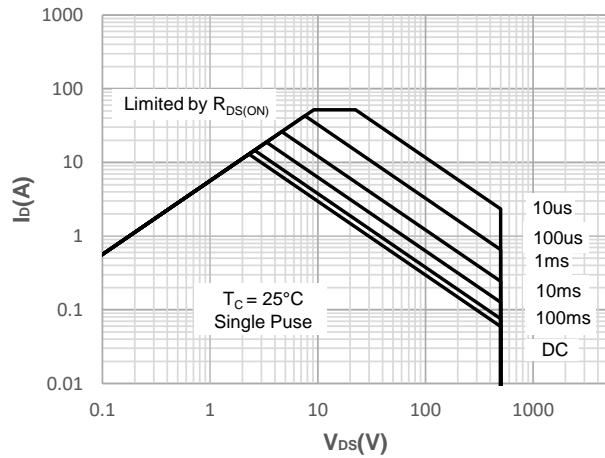
**Figure 7: Normalized Breakdown voltage vs. Junction Temperature**



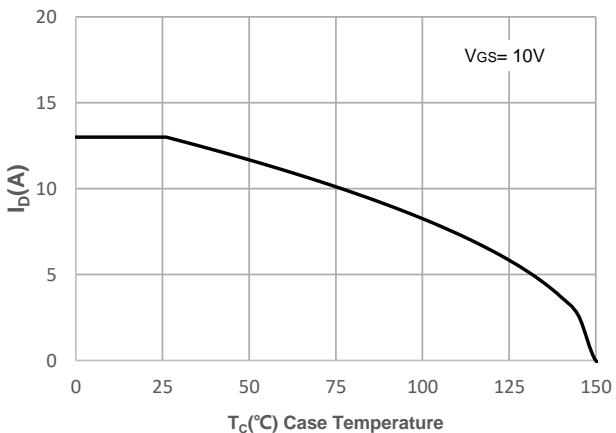
**Figure 8: Normalized on Resistance vs. Junction Temperature**



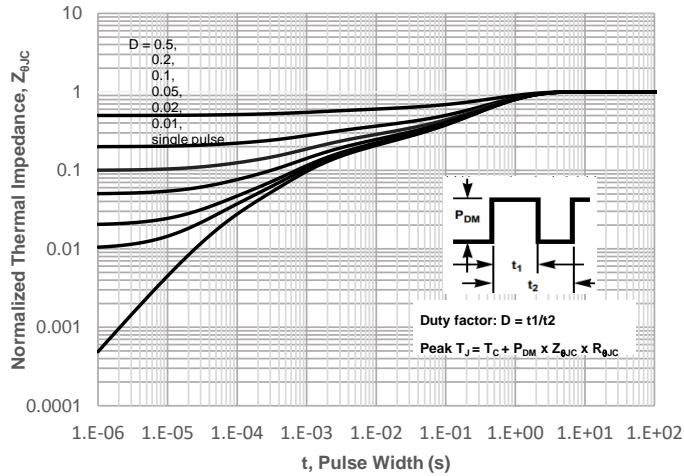
**Figure 9: Maximum Safe Operating Area**



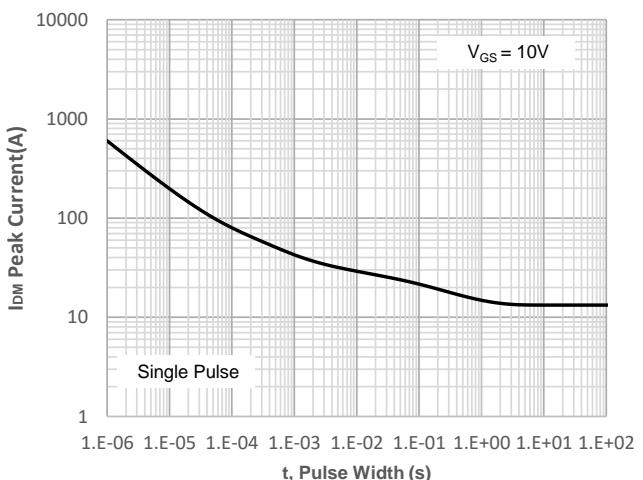
**Figure 10: Maximum Continuous Drian Current vs. Case Temperature**



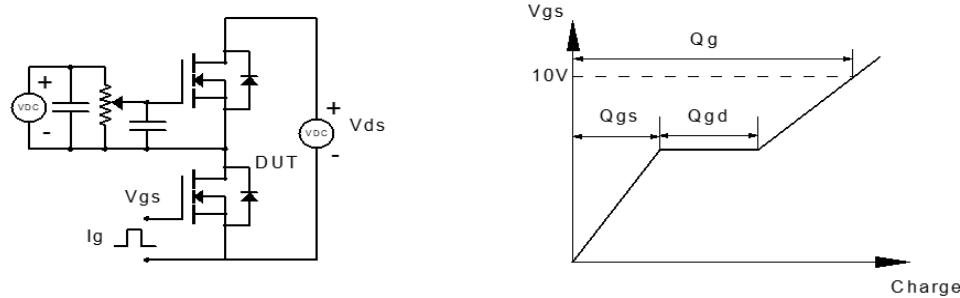
**Figure 11: Normalized Maximum Transient Thermal Impedance**



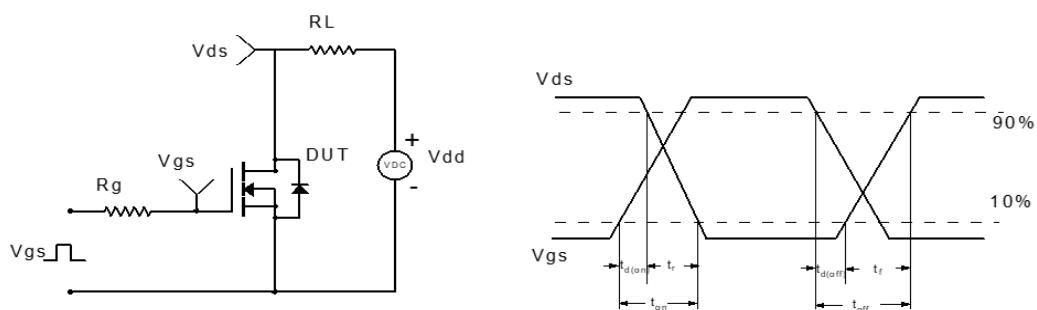
**Figure 12: Peak Current Capacity**



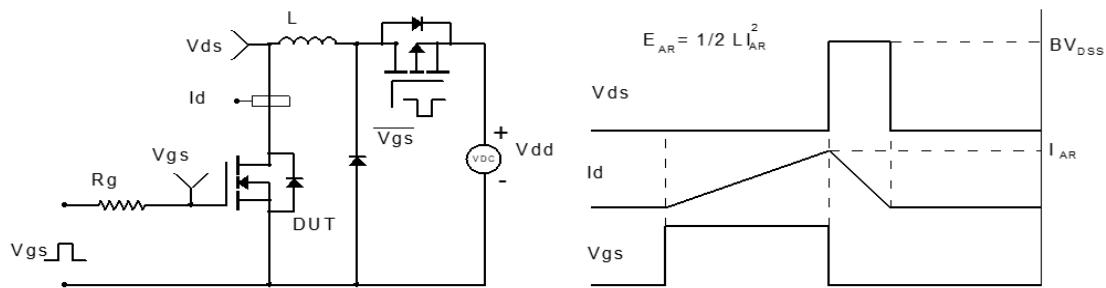
## Test Circuit



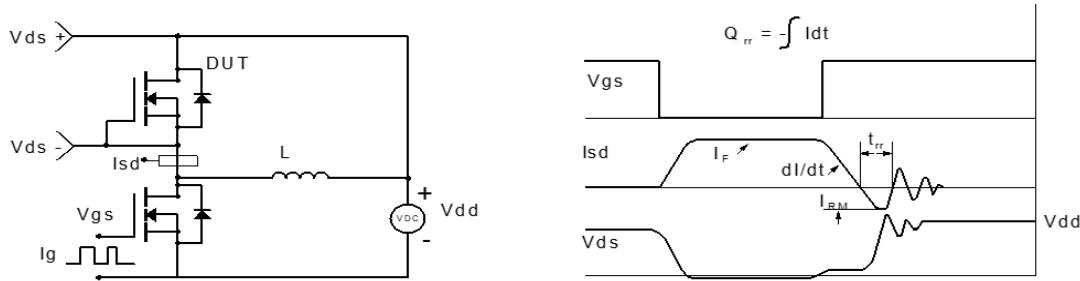
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**



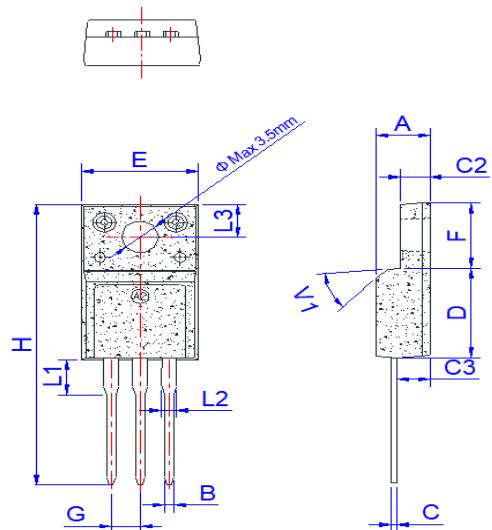
**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**



## Package Mechanical Data(TO-220FP-3L)



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.50		4.90	0.177		0.193
B	0.74	0.80	0.83	0.029	0.031	0.033
C	0.47		0.65	0.019		0.026
C2	2.45		2.75	0.096		0.108
C3	2.60		3.00	0.102		0.118
D	8.80		9.30	0.346		0.366
E	9.80		10.4	0.386		0.410
F	6.40		6.80	0.252		0.268
G		2.54			0.1	
H	28.0		29.8	1.102		1.173
L1		3.63			0.143	
L2	1.14		1.70	0.045		0.067
L3		3.30			0.130	
V1		45°			45°	

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